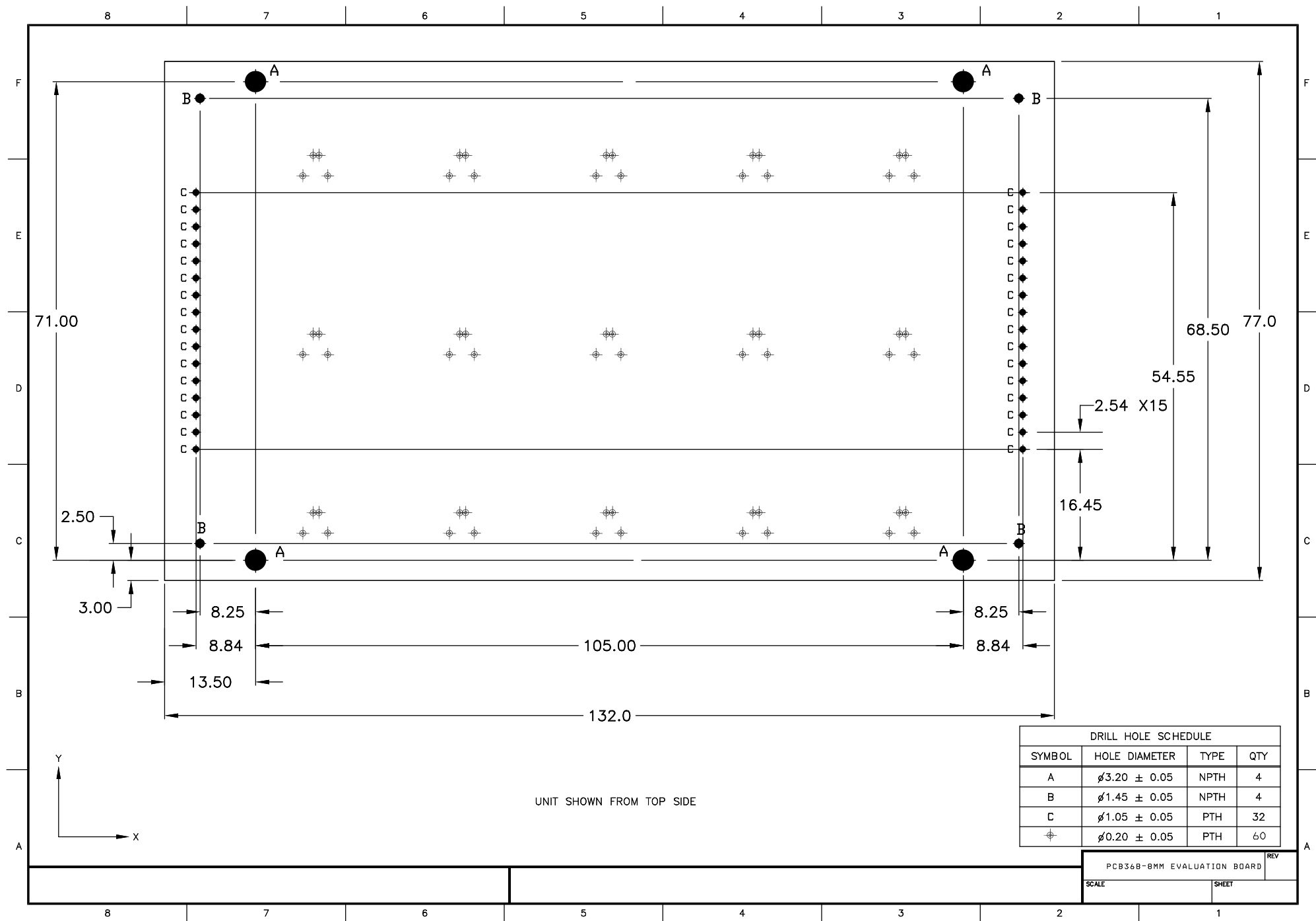




NOTES: UNLESS OTHERWISE SPECIFIED
GENERAL SPECIFICATION1. UNLESS OTHERWISE SPECIFIED FABRICATE
PER IPC-A-600

2. PLATED THROUGH HOLE COPPER MIN. 15um

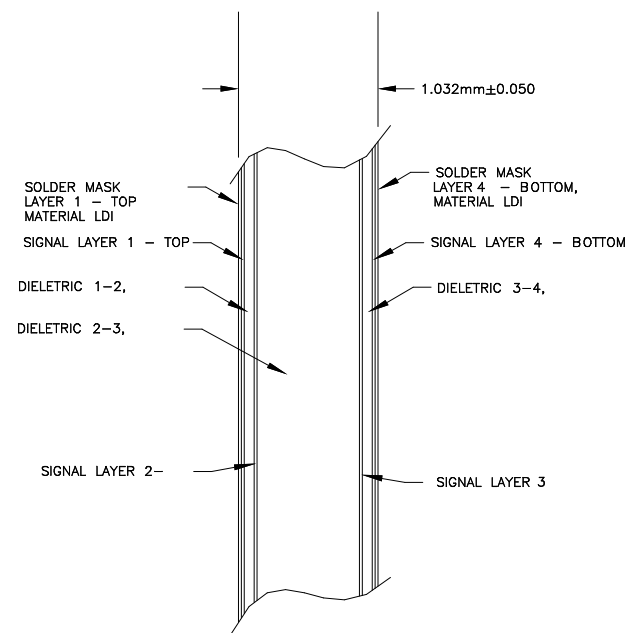
3. SOLDER MASK TO BE LASER DIRECT IMAGE
COLOR GREEN, APPLY SOLDER MASK OVER BARE COPPER.
SOLDER MASK REGISTRATION +/- 25um4. FINISH ON ALL SOLDERABLE SURFACES
OSP - ENTEK PLUS, Cu - 106A OR EQUIVALENT
Ni/Au - Ni : 3 ~ 15um , Au : 0.03 ~ 0.15um5. SILKSCREEN - BOTH SIDES - COLOR WHITE.
SILKSCREEN IS NOT PERMITTED ON PADS.

6. HOLE SIZES ARE FINISHED SIZE, TOLERANCE +/- 76um

7. COPPER PAD DIAMETER TO BE +/- 15um

8. LOCATE VENDOR LOGO AND DATE CODE ON BOARD, PREFER BOTTOM SIDE.

9. WARP AND TWIST SHALL NOT EXCEED .005 (.127) INCH PER INCH

10. GERBER FILES ARE GENERATED AT NOMINAL DIMENSIONS. VENDOR IS
AUTHORIZED TO BIAS PHOTO TOOLS TO ACCOMMODATE VENDOR PROCESS.

CROSS SECTION

UNLESS OTHERWISE SPECIFIED
DIMENSIONS ARE IN MILLIMETERS

DECIMAL	ANGULAR
X.X ±0.1	±1°
X.XX ±0.05	
X.XXX ±0.030	

INTERPRET DIM AND TOL PER
ASME Y14.5M - 1994

MATERIAL

SEE NOTES

FINISH

SEE NOTES

THIRD ANGLE
PROJECTION

PCB368-8MM EVALUATION BOARD

TITLE
BEND/DROP TEST BOARD,
CVBGA, 368LD, 8.00mm X 8.00mm BODY,
0.30mm PITCH, 15 UP